LP2957/LP2957A 5V Low-Dropout Regulator for µP Applications

Check for Samples: LP2957, LP2957A

FEATURES

- **5V Output within 1.4% Over Temperature (A Grade)**
- **Easily Programmed for Snap-On/Snap-Off Output**
- **Ensured 250 mA Output Current**
- **Extremely Low Quiescent Current**
- **Low Input-Output Voltage Required for Regulation**
- **Reverse Battery Protection**
- **Extremely Tight Line and Load Regulation**
- **Very Low Temperature Coefficient**
- **Current and Thermal Limiting**
- **Error Flag Signals when Output is out of Regulation**

APPLICATIONS

- **High-Efficiency Linear Regulator**
- **Battery-Powered Regulator**

DESCRIPTION

The LP2957 is a 5V micropower voltage regulator with electronic shutdown, error flag, very low quiescent current (150 µA typical at 1 mA load), and very low dropout voltage (470 mV typical at 250 mA load current).

Output can be wired for snap-on/snap-off operation to eliminate transition voltage states where µP operation may be unpredictable.

Output crowbar (50 mA typical pull-down current) will bring down the output quickly when the regulator snaps off or when the shutdown function is activated.

The part has tight line and load regulation (0.04% typical) and low output temperature coefficient (20 ppm/°C typical).

The accuracy of the 5V output is ensured at room temperature and over the full operating temperature range.

The LP2957 is available in the five-lead TO-220 and DDPAK/TO-263 packages.

Package Outline

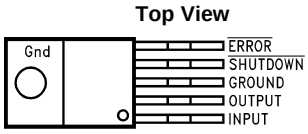


Figure 1. Bent, Staggered Leads
5-Lead TO-220 Package
See Package Number NDH0005D

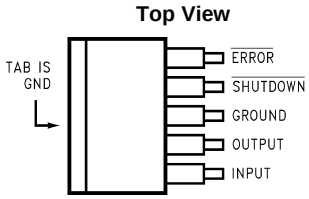


Figure 2. Plastic Surface Mount Package
5-Lead DDPAK/TO-263 Package
See Package Number KTT0005B

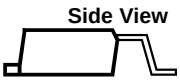


Figure 3. See Package Number KTT0005B

These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

All trademarks are the property of their respective owners.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of the Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

Copyright © 1998–2013, Texas Instruments Incorporated

Absolute Maximum Ratings[1][2]

Operating Junction	Temperature Range	−40°C to +125°C
Storage Temperature Range		−65°C to +150°C
Lead Temperature (Soldering, 5 Seconds)		260°C
Power Dissipation[3]		Internally Limited
Input Supply Voltage		−20V to +30V
$\overline{\text{Shutdown}}$ Input		−0.3V to +30V
ESD Rating		2 kV

(1) Absolute maximum ratings indicate limits beyond which damage to the component may occur. Electrical specifications do not apply when operating the device outside of its rated operating conditions.
(2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.
(3) The maximum allowable power dissipation is a function of the maximum junction temperature, $T_J(MAX)$, the junction-to-ambient thermal resistance, θ_{JA}, and the ambient temperature, T_A. The maximum allowable power dissipation at any ambient temperature is calculated using: $P(MAX) = \frac{T_J(MAX) - T_A}{\theta_{JA}}$ Exceeding the maximum allowable power dissipation will result in excessive die temperature, and the regulator will go into thermal shutdown. The junction-to-ambient thermal resistance of the TO-220 (without heatsink) is 60°C/W and 73°C/W for the DDPAK/TO-263. If the DDPAK/TO-263 package is used, the thermal resistance can be reduced by increasing the P.C. board copper area thermally connected to the package: Using 0.5 Square inches of copper area, θ_{JA} is 50°C/W, with 1 square inch of copper area, θ_{JA} is 37°C/W; and with 1.6 or more square inches of copper area, θ_{JA} is 32°C/W. The junction-to-case thermal resistance is 3°C/W. If an external heatsink is used, the effective junction-to-ambient thermal resistance is the sum of the junction-to-case resistance (3°C/W), the specified thermal resistance of the heatsink selected, and the thermal resistance of the interface between the heatsink and the LP2957 (see Application Hints).

Electrical Characteristics

Limits in standard typeface are for T_J = 25°C, and limits in **boldface type** apply over the full operating temperature range. Unless otherwise specified: V_{IN} = 6V, I_L = 1 mA, C_L = 2.2 µF, V_{SD} = 3V.

Symbol	Parameter	Conditions	Typical	LP2957AI		LP2957I		Units
				Min	Max	Min	Max	
V_O	Output Voltage[1]		5.0	4.975	5.025	4.950	5.050	V
				4.940	**5.060**	**4.900**	**5.100**	
		1 mA ≤ I_L ≤ 250 mA	5.0	**4.930**	**5.070**	**4.880**	**5.120**	
$\frac{\Delta V_O}{\Delta T}$	Output Voltage Temperature Coefficient	See[2]	**20**		**100**		**150**	ppm/°C
$\frac{\Delta V_O}{V_O}$	Line Regulation	V_{IN} = 6V to 30V	0.03		0.10		0.20	%
					0.20		**0.40**	
$\frac{\Delta V_O}{V_O}$	Load Regulation	I_L = 1 mA to 250 mA	0.04		0.16		0.20	%
		I_L = 0.1 mA to 1 mA[3]			**0.20**		**0.30**	
V_{IN}–V_O	Dropout Voltage[4]	I_L = 1 mA	60		100		100	mV
					150		**150**	
		I_L = 50 mA	240		300		300	
					420		**420**	
		I_L = 100 mA	310		400		400	
					520		**520**	
		I_L = 250 mA	470		600		600	
					800		**800**	

(1) When used in dual-supply systems where the regulator load is returned to a negative supply, the output voltage must be diode-clamped to ground.
(2) Output voltage temperature coefficient is defined as the worst case voltage change divided by the total temperature range.
(3) Regulation is measured at constant junction temperature using low duty cycle pulse testing. Parts are tested separately for load regulation in the load ranges 0.1 mA–1 mA and 1 mA–250 mA. Changes in output voltage due to heating effects are covered by the thermal regulation specification.
(4) Dropout voltage is defined as the input to output voltage differential at which the output voltage drops 100 mV below the value measured with a 1V input to output differential.

Copyright © 1998–2013, Texas Instruments Incorporated

Electrical Characteristics (continued)

Limits in standard typeface are for T_J = 25°C, and limits in **boldface type** apply over the full operating temperature range. Unless otherwise specified: V_{IN} = 6V, I_L = 1 mA, C_L = 2.2 µF, V_{SD} = 3V.

Symbol	Parameter	Conditions	Typical	LP2957AI		LP2957I		Units
				Min	Max	Min	Max	
I_{GND}	Ground Pin Current(5)	I_L = 1 mA	150		200 **230**		200 **230**	µA
		I_L = 50 mA	1.1		2 **2.5**		2 **2.5**	mA
		I_L = 100 mA	3		6 **8**		6 **8**	
		I_L = 250 mA	16		28 **33**		28 **33**	
I_{GND}	Ground Pin Current in Shutdown(5)	I_L = 0	130		180		180	µA
		V_{SD} = 0.4V			**200**		**200**	
I_{GND}	Ground Pin Current at Dropout(5)	V_{IN} = 4.5V	180		230		230	µA
		I_L = 0.1 mA			**250**		**250**	
I_O (Sink)	Off-State Output Pulldown Current	V_{IN} = 5.3V V_O = 5V, V_{SD} = 0.4V	50	30 **20**		30 **20**		mA
I_O (Off)	Output Leakage in Shutdown	$I_{(SD\ IN)} \geq 1$ µA V_{IN} = 30V, V_{OUT} = 0V	3		10 **20**		10 **20**	µA
I_{LIMIT}	Current Limit	R_L = 1Ω	400		500 **530**		500 **530**	mA
$\frac{\Delta V_O}{\Delta Pd}$	Thermal Regulation	See(6)	0.05		0.2		0.2	%/W
e_n	Output Noise Voltage (10 Hz to 100 kHz) I_L = 100 mA	C_L = 2.2 µF	500					µV RMS
		C_L = 33 µF	320					
$\overline{\text{SHUTDOWN}}$ INPUT								
V_{SD} (ON)	Output Turn-On Threshold Voltage			1.155 **1.140**	1.305 **1.320**	1.155 **1.140**	1.305 **1.320**	V
HYST	Hysteresis		6					mV
I_B	Input Bias Current	$V_{IN(SD)}$ = 0V to 5V	10	−30 **−50**	30 **50**	−30 **−50**	30 **50**	nA
DROPOUT DETECTION COMPARATOR								
I_{OH}	Output “HIGH” Leakage	V_{OH} = 30V	0.01		1 **2**		1 **2**	µA
V_{OL}	Output “LOW” Voltage	V_{IN} = 4V I_O(COMP) = 400 µA	150		250 **400**		250 **400**	mV
V_{THR} (Max)	Upper Threshold Voltage	See(7)	−240	−320 **−380**	−150 **−100**	−320 **−380**	−150 **−100**	mV
V_{THR} (Min)	Lower Threshold Voltage	See(7)	−350	−450 **−640**	−230 **−160**	−450 **−640**	−230 **−160**	mV
HYST	Hysteresis	See(7)	60					mV

(5) Ground pin current is the regulator quiescent current. The total current drawn from the source is the sum of the load current plus the ground pin current.
(6) Thermal regulation is defined as the change in output voltage at a time T after a change in power dissipation is applied, excluding load or line regulation effects. Specifications are for a 200 mA load pulse at V_{IN} = 20V (3W pulse) for T = 10 ms.
(7) Voltages are referenced to the nominal regulated output voltage.

Copyright © 1998–2013, Texas Instruments Incorporated

Typical Performance Characteristics

Unless otherwise specified: V_{IN} = 6V, I_L = 1 mA, C_L = 2.2 µF, V_{SD} = 3V, T_A = 25°C

Ground Pin Current

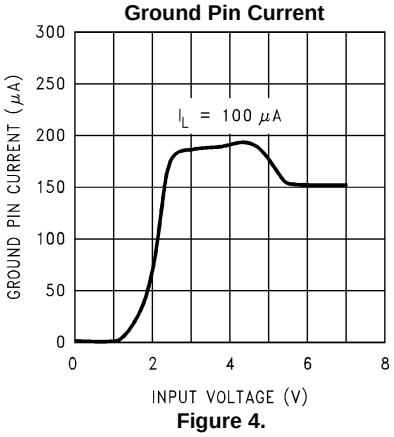


Figure 4.

Ground Pin Current

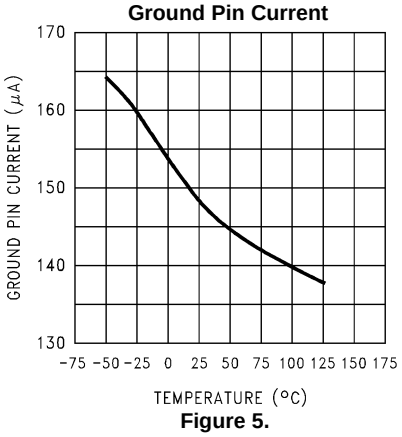


Figure 5.

Ground Pin Current vs Load

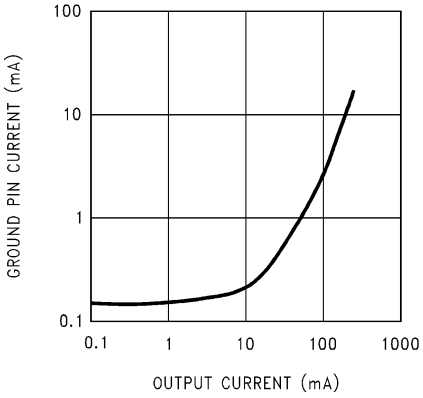


Figure 6.

Ground Pin Current

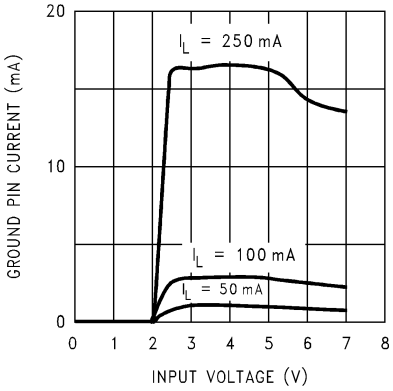


Figure 7.

Ground Pin Current

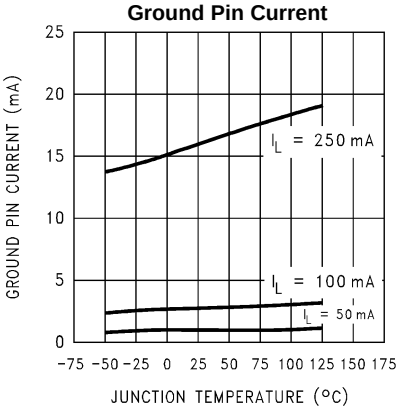


Figure 8.

Output Noise Voltage

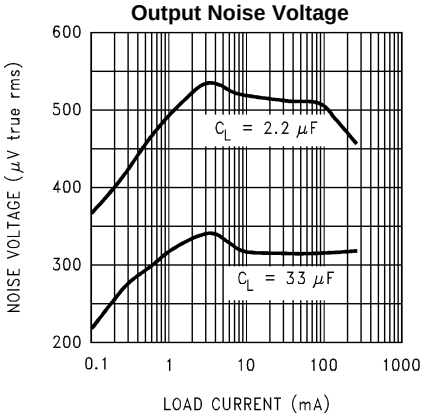


Figure 9.

Copyright © 1998–2013, Texas Instruments Incorporated

Typical Performance Characteristics (continued)

Unless otherwise specified: V_{IN} = 6V, I_L = 1 mA, C_L = 2.2 µF, V_{SD} = 3V, T_A = 25°C

Ripple Rejection

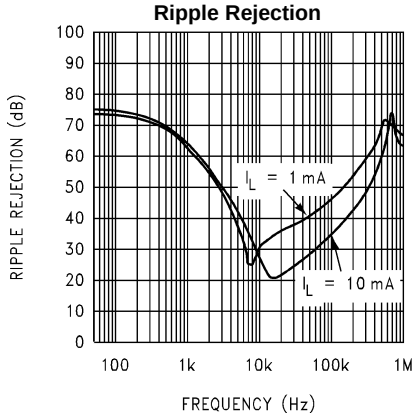


Figure 10.

Ripple Rejection

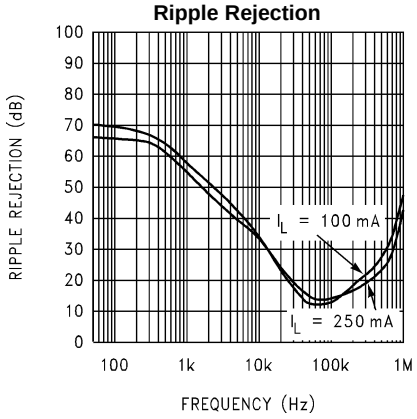


Figure 11.

Ripple Rejection

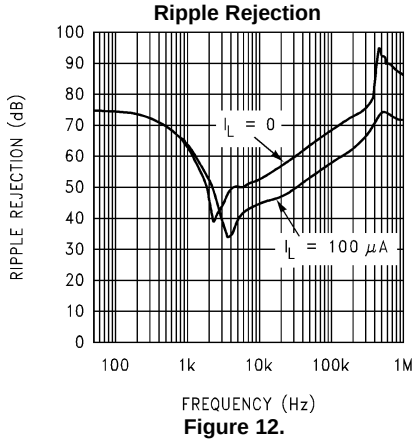


Figure 12.

Line Transient Response

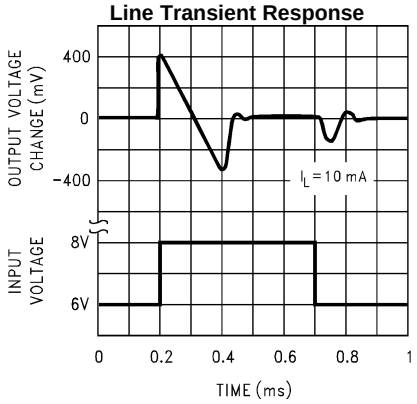


Figure 13.

Line Transient Response

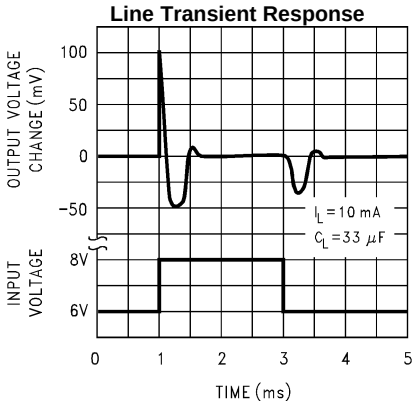


Figure 14.

Output Impedance

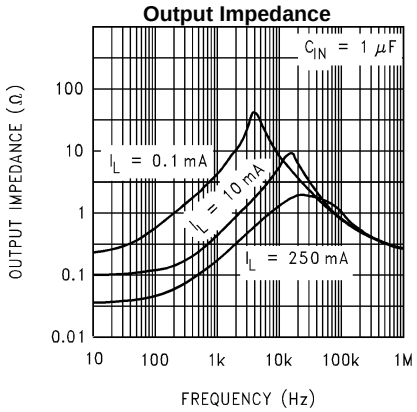


Figure 15.

Copyright © 1998–2013, Texas Instruments Incorporated

Typical Performance Characteristics (continued)

Unless otherwise specified: V_{IN} = 6V, I_L = 1 mA, C_L = 2.2 µF, V_{SD} = 3V, T_A = 25°C

Load Transient Response

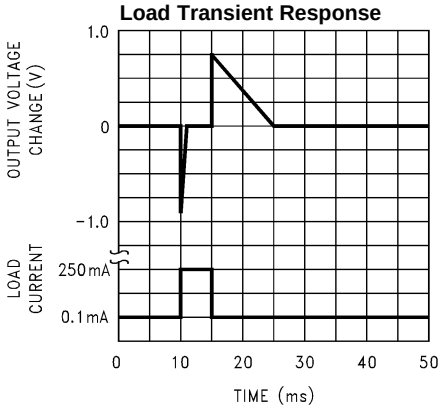


Figure 16.

Load Transient Response

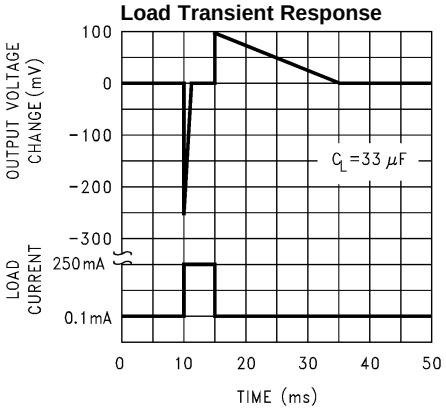


Figure 17.

Dropout Characteristics

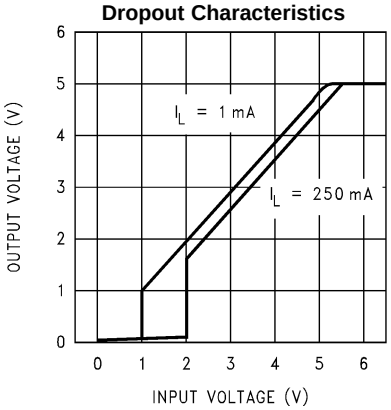


Figure 18.

Enable Transient

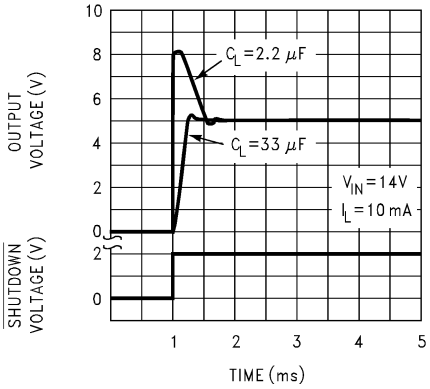


Figure 19.

Enable Transient

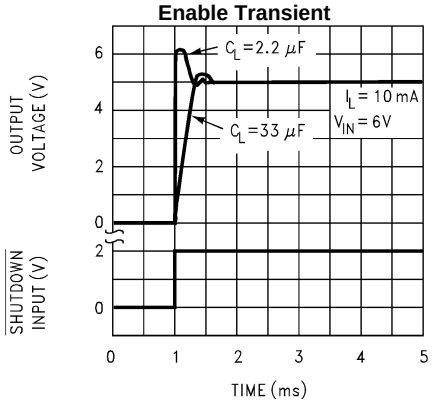


Figure 20.

Short-Circuit Output Current and Maximum Output Current

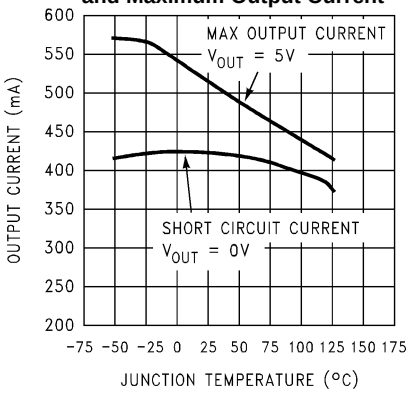


Figure 21.

Copyright © 1998–2013, Texas Instruments Incorporated

Typical Performance Characteristics (continued)

Unless otherwise specified: V_{IN} = 6V, I_L = 1 mA, C_L = 2.2 µF, V_{SD} = 3V, T_A = 25°C

Thermal Regulation

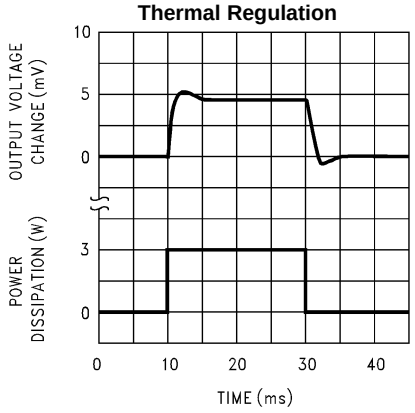


Figure 22.

Error Output Sink Current

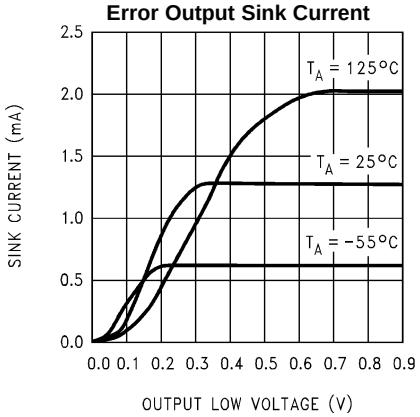


Figure 23.

Dropout Detection Threshold Voltages

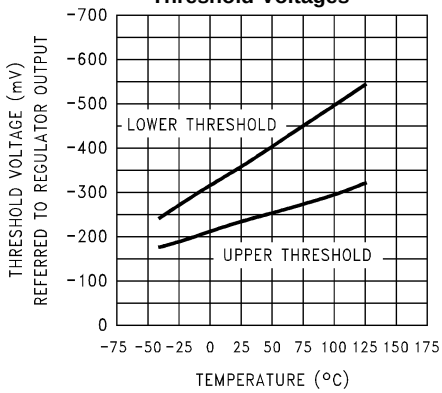


Figure 24.

Maximum Power Dissipation (DDPAK/TO-263)(1)

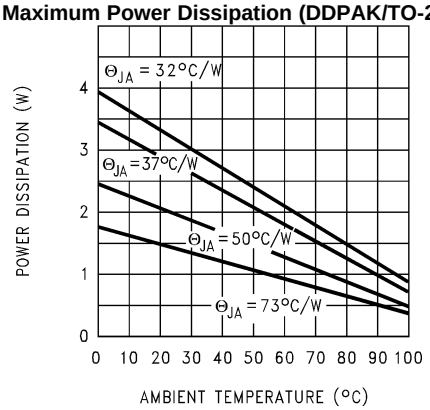


Figure 25.

Error Output Voltage

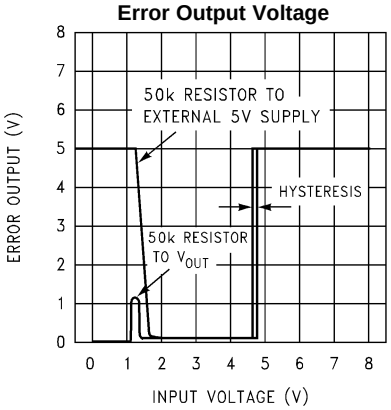


Figure 26.

Dropout Voltage

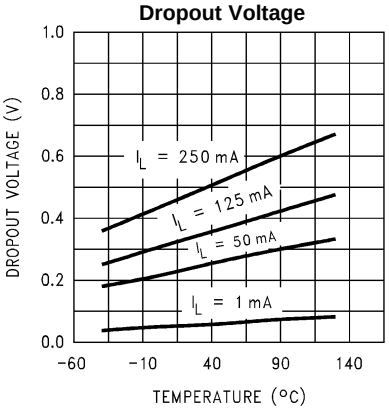
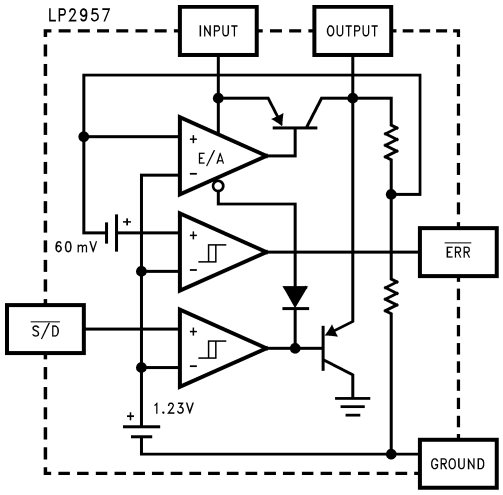


Figure 27.

(1) The maximum allowable power dissipation is a function of the maximum junction temperature, T_J(MAX), the junction-to-ambient thermal resistance, θ_{JA}, and the ambient temperature, T_A. The maximum allowable power dissipation at any ambient temperature is calculated using: $P(MAX) = \frac{T_J(MAX) - T_A}{\theta_{JA}}$ Exceeding the maximum allowable power dissipation will result in excessive die temperature, and the regulator will go into thermal shutdown. The junction-to-ambient thermal resistance of the TO-220 (without heatsink) is 60°C/W and 73°C/W for the DDPAK/TO-263. If the DDPAK/TO-263 package is used, the thermal resistance can be reduced by increasing the P.C. board copper area thermally connected to the package: Using 0.5 Square inches of copper area, θ_{JA} is 50°C/W, with 1 square inch of copper area, θ_{JA} is 37°C/W; and with 1.6 or more square inches of copper area, θ_{JA} is 32°C/W. The junction-to-case thermal resistance is 3°C/W. If an external heatsink is used, the effective junction-to-ambient thermal resistance is the sum of the junction-to-case resistance (3°C/W), the specified thermal resistance of the heatsink selected, and the thermal resistance of the interface between the heatsink and the LP2957 (see Application Hints).

Copyright © 1998–2013, Texas Instruments Incorporated

Block Diagram



Typical Application Circuits

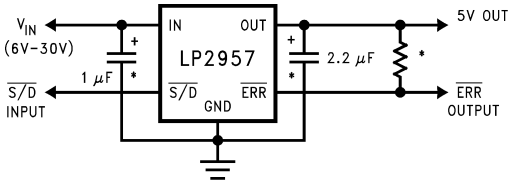
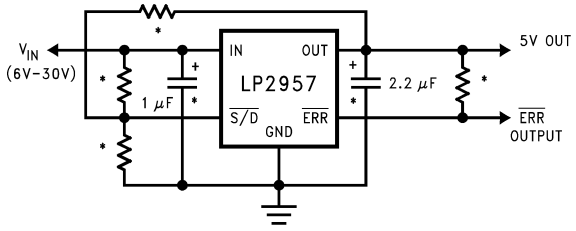


Figure 28. LP2957 Basic Application



*See Application Hints

Figure 29. LP2957 Application with Snap-On/Snap-Off Output

Copyright © 1998–2013, Texas Instruments Incorporated

APPLICATION HINTS

EXTERNAL CAPACITORS

A 2.2 µF (or greater) capacitor is required between the output pin and ground to assure stability (refer to Figure 30). Without this capacitor, the part may oscillate. Most type of tantalum or aluminum electrolytics will work here. Film types will work, but are more expensive. Many aluminum electrolytics contain electrolytes which freeze at −30°C, which requires the use of solid tantalums below −25°C. The important parameters of the capacitor are an ESR of about 5Ω or less and a resonant frequency above 500 kHz (the ESR may increase by a factor of **20** or **30** as the temperature is reduced from 25°C to −30°C). The value of this capacitor may be increased without limit. At lower values of output current, less output capacitance is required for stability. The capacitor can be reduced to 0.68 µF for currents below 10 mA or 0.22 µF for currents below 1 mA.

A 1 µF capacitor should be placed from the input pin to ground if there is more than 10 inches of wire between the input and the AC filter capacitor or if a battery input is used. This **capacitor may have to be increased if the regulator is wired for snap-on/snap-off output and the source impedance is high** (see Snap-On/Snap-Off Operation section).

SHUTDOWN INPUT

A logic-level signal will shut off the regulator output when a “LOW” (< 1.2V) is applied to the $\overline{\text{Shutdown}}$ input.

To prevent possible mis-operation, the $\overline{\text{Shutdown}}$ input must be actively terminated. If the input is driven from open-collector logic, a pull-up resistor (20 kΩ to 100 kΩ recommended) must be connected from the $\overline{\text{Shutdown}}$ input to the regulator input.

If the $\overline{\text{Shutdown}}$ input is driven from a source that actively pulls high and low (like an op-amp), the pull-up resistor is not required, but may be used.

If the shutdown function is not to be used, the cost of the pull-up resistor can be saved by tying the $\overline{\text{Shutdown}}$ input directly to the regulator input.

IMPORTANT: Since the Absolute Maximum Ratings state that the $\overline{\text{Shutdown}}$ input can not go more than 0.3V below ground, the reverse-battery protection feature which protects the regulator input is sacrificed if the $\overline{\text{Shutdown}}$ input is tied directly to the regulator input.

If reverse-battery protection is required in an application, the pull-up resistor between the $\overline{\text{Shutdown}}$ input and the regulator input must be used.

MINIMUM LOAD

It should be noted that a minimum load current is specified in several of the electrical characteristic test conditions, so the value listed must be used to obtain correlation on these tested limits. The part is parametrically tested down to 100 µA, but is functional with no load.

DROPOUT VOLTAGE

The dropout voltage of the regulator is defined as the minimum input-to-output voltage differential required for the output voltage to stay within 100 mV of the output voltage measured with a 1V differential. The dropout voltages for various values of load current are listed under Electrical Characteristics.

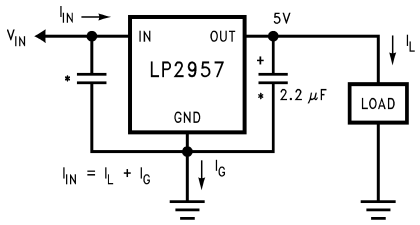
If the regulator is powered from a transformer connected to the AC line, the **minimum AC line voltage** and **maximum load current** must be used to measure the minimum voltage at the input of the regulator. The minimum input voltage is the lowest voltage level **including ripple on the filter capacitor** . It is also advisable to verify operation at **minimum operating ambient temperature** , since the increasing ESR of the filter capacitor makes this a worst-case test due to increased ripple amplitude.

Copyright © 1998–2013, Texas Instruments Incorporated

HEATSINK REQUIREMENTS

A heatsink may be required with the LP2957 depending on the maximum power dissipation and maximum ambient temperature of the application. Under all possible operating conditions, the junction temperature must be within the range specified under Absolute Maximum Ratings.

To determine if a heatsink is required, the maximum power dissipated by the regulator, P(max), must be calculated. It is important to remember that if the regulator is powered from a transformer connected to the AC line, the **maximum specified AC input voltage** must be used (since this produces the maximum DC input voltage to the regulator), and the **maximum load current** must also be used. Figure 30 shows the voltages and currents which are present in the circuit. The formula for calculating the power dissipated in the regulator is also shown in Figure 30.



$P_{TOTAL} = (V_{IN} - 5)I_L + (V_{IN})I_G$
*See EXTERNAL CAPACITORS

Figure 30. Basic 5V Regulator Circuit

The next parameter which must be calculated is the maximum allowable temperature rise, $T_R(Max)$. This is calculated by using the formula:

$T_R(Max) = T_J(Max) - T_A(Max)$

where

- $T_J(Max)$ is the maximum allowable junction temperature
- $T_A(Max)$ is the maximum ambient temperature (1)

Using the calculated values for $T_R(Max)$ and P(Max), the required value for junction-to-ambient thermal resistance, $\theta_{(JA)}$, can now be found:

$\theta_{(JA)} = T_R(Max)/P(Max)$ (2)

If the calculated value is 60°C/W **or higher** , the regulator may be operated without an external heatsink. If the calculated value is **below** 60°C/W, an external heatsink is required. The required thermal resistance for this heatsink, $\theta_{(HA)}$, can be calculated using the formula:

$\theta_{(HA)} = \theta_{(JA)} - \theta_{(JC)} - \theta_{(CH)}$

where

- $\theta_{(JC)}$ is the junction-to-case thermal resistance, which is specified as 3°C/W for the LP2957
- $\theta_{(CH)}$ is the case-to-heatsink thermal resistance, which is dependent on the interfacing material (see Table 1 and Table 2) (3)

Typical TO-220 Case-To-Heatsink

Thermal Resistance in °C/W

Table 1. (From AAVID)

Silicone Grease	1.0
Dry Interface	1.3
Mica with Grease	1.4

Copyright © 1998–2013, Texas Instruments Incorporated

Table 2. (From Thermalloy)

Thermasil III	1.3
Thermasil II	1.5
Thermalfilm (0.002) with Grease	2.2

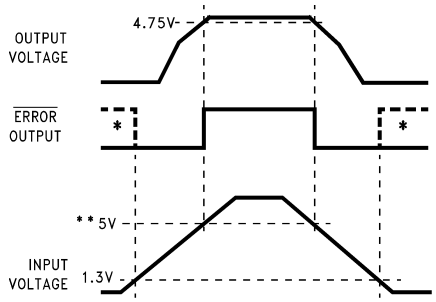
$\theta_{(HA)}$ is the heatsink-to-ambient thermal resistance. It is this specification (listed on the heatsink manufacturers data sheet) which defines the effectiveness of the heatsink. The heatsink selected must have a thermal resistance which is **equal to or lower** than the value of $\theta_{(HA)}$calculated from the above listed formula.

ERROR COMPARATOR

This comparator produces a logic “LOW” whenever the output falls out of regulation by more than about 5%. This figure results from the comparator's built-in offset of 60 mV divided by the 1.23V reference. An out-of-regulation condition can result from low input voltage, current limiting, or thermal limiting.

Figure 31 gives a timing diagram showing the relationship between the output voltage, the $\overline{\text{ERROR}}$ output, and input voltage as the input voltage is ramped up and down to the regulator **without snap-on/snap-off output**. The $\overline{\text{ERROR}}$ signal becomes low at about 1.3V input. It goes high at about 5V input, where the output equals 4.75V. Since the dropout voltage is load dependent, the **input** voltage trip points will vary with load current. The **output** voltage trip point does not vary.

The comparator has an open-collector output which requires an external pull-up resistor. This resistor may be connected to the regulator output or some other supply voltage. Using the regulator output prevents an invalid “HIGH” on the comparator output which occurs if it is pulled up to an external voltage while the regulator input voltage is reduced below 1.3V. In selecting a value for the pull-up resistor, note that while the output can sink 400 µA, this current adds to battery drain. Suggested values range from 100k to 1 MΩ. The resistor is not required if the output is unused.



*In shutdown mode, $\overline{\text{ERROR}}$ will go high if it has been pulled up to an external supply. To avoid this invalid response, pull up to regulator output.
**Exact value depends on dropout voltage, which varies with load current.

Figure 31. $\overline{\text{ERROR}}$ Output Timing

If a single pull-up resistor is connected to the regulator output, the error flag may briefly rise up to about 1.3V as the input voltage ramps up or down through the 0V to 1.3V region.

In some cases, this 1.3V signal may be mis-interpreted as a false high by a µP which is still “alive” with 1.3V applied to it.

To prevent this, the user may elect to use **two** resistors which are equal in value on the error output (one connected to ground and the other connected to the regulator output).

If this two-resistor divider is used, the error output will only be pulled up to about 0.6V (not 1.3V) during power-up or power-down, so it can not be interpreted as a high signal. When the regulator output is in regulation (4.8V to 5V), the error output voltage will be 2.4V to 2.5V, which is clearly a high signal.

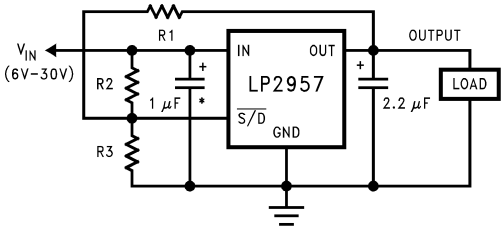
OUTPUT ISOLATION

The regulator output can be connected to an active voltage source (such as a battery) with the regulator input turned off, **as long as the regulator ground pin is connected to ground**. If the ground pin is left floating, **damage to the regulator can occur** if the output is pulled up by an external voltage source.

Copyright © 1998–2013, Texas Instruments Incorporated

SNAP-ON/SNAP-OFF OPERATION

The LP2957 output can be wired for snap-on/snap-off operation using three external resistors:



*Minimum value (increase as required for smooth turn-on characteristic).

Figure 32. Snap-On/Snap-Off Output

When connected as shown, the shutdown input holds the regulator off until the input voltage rises up to the turn-on threshold (V_{ON}), at which point the output "snaps on".

When the input power is shut off (and the input voltage starts to decay) the output voltage will snap off when the input voltage reaches the turn-off threshold, V_{OFF}.

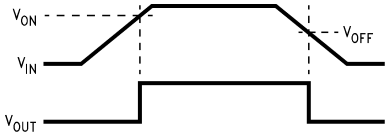


Figure 33. Snap-On/Snap-Off Input and Output Voltage Diagram

It is important to note that the voltage V_{OFF} must always be lower than V_{ON} (the difference in these voltage levels is called the hysteresis).

Hysteresis is **required** when using snap-on/snap-off output, with the minimum amount of hysteresis required for a specific application being dependent on the source impedance of whatever is supplying V_{IN}.

Caution: A type of **low-frequency oscillation** can occur if V_{ON} and $V_{OFF}$are too close together (**insufficient hysteresis**). When the output snaps on, the regulator must draw sufficient current to power the load and charge up the output capacitor (in most cases, the regulator will briefly draw the maximum current allowed by its internal limiter).

For this reason, it is best to assume the LP2957 may pull a peak current of about **600 mA** from the source (which is the listed maximum short-circuit load current of **530 mA** plus the ground pin current of **70 mA**).

This high peak current causes V_{IN} to drop by an amount equal to the source impedance multiplied by the current. If V_{IN} drops below V_{OFF}, the regulator will turn off and stop drawing current from the source. This will allow V_{IN} to rise back up above V_{ON}, and the cycle will start over. The regulator will stay in this oscillating mode and never come into regulation.

HYSTERESIS IN TRANSFORMER-POWERED

APPLICATIONS:

If the unregulated DC input voltage to the regulator comes from a transformer, the required hysteresis is easily measured by loading the source with a resistive load.

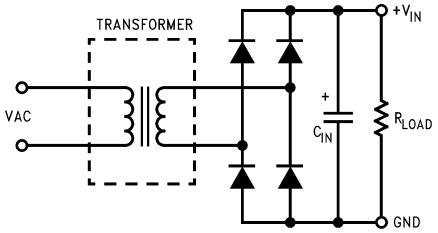


Figure 34. Transformer Powered Input Supply

Copyright © 1998–2013, Texas Instruments Incorporated

If the regulator is powered from a battery, the source impedance will probably be low enough that other considerations will determine the optimum values for hysteresis (see Design Example #2).

For best results, the load resistance used to test the transformer should be selected to draw about **600 mA** for the maximum load current test, since this is the maximum peak current the LP2957 could be expected to draw from the source.

The difference in input voltage measured at no load and full load defines the amount of hysteresis required for proper snap-on/snap-off operation (the programmed hysteresis must be **greater** than the difference in voltages).

CALCULATING RESISTOR VALUES:

The values of R1, R2 and R3 can be calculated assuming the designer knows the hysteresis.

In most transformer-powered applications, it can be assumed that $\mathbf{V_{OFF}}$ (the input voltage at turn-off) **should be set for about 5.5V,** since this allows about 500 mV across the LP2957 to keep the output in regulation until it snaps off. $\mathbf{V_{ON}}$ (the input voltage at turn on) is found by **adding the hysteresis voltage to V_{OFF}.**

R1, R2 and R3 are found by solving the node equations for the currents entering the node nearest the shutdown pin (written at the turn-on and turn-off thresholds).

The shutdown pin bias current (10 nA typical) is not included in the calculations:

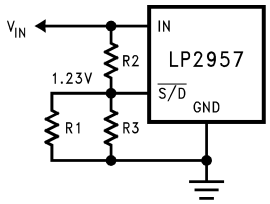


Figure 35. Turn-ON Transition - Equivalent Circuit

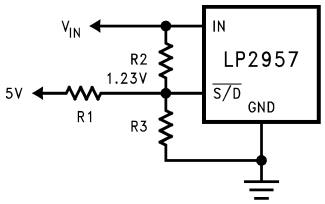


Figure 36. Turn-OFF Transition - Equivalent Circuits

$$\left(\frac{V_{ON} - 1.23}{R2}\right) = \frac{1.23}{R1} + \frac{1.23}{R3} \quad \text{(TURN-ON)}$$

$$\frac{V_{OFF} - 1.23}{R2} + \frac{5 - 1.23}{R1} = \frac{1.23}{R3} \quad \text{(TURN-OFF)} \tag{4}$$

Since these **two** equations contain **three** unknowns (R1, R2 and R3) one resistor value must be assumed and then the remaining two values can be obtained by solving the equations.

The node equations will be simplified by solving both equations for R2, and then equating the two to generate an expression in terms of R1 and R3.

$$R2 = \frac{(R1 \times R3) \times (V_{ON} - 1.23)}{1.23 \times (R1 + R3)} \quad \text{(TURN-ON)}$$

$$R2 = \frac{(R1 \times R3) \times (V_{OFF} - 1.23)}{(1.23R1 - 3.77R3)} \quad \text{(TURN-OFF)} \tag{5}$$

Setting these equal to each other and solving for R1 yields:

$$R1 = \frac{R3 \times (V_{OFF} + 3.07V_{ON} - 5)}{V_{ON} - V_{OFF}} \tag{6}$$

The same equation solved for R3 is:

$$R3 = \frac{R1 \times (V_{ON} - V_{OFF})}{V_{OFF} + 3.07V_{ON} - 5} \tag{7}$$

A value for R1 or R3 can be derived using either one of the above equations, if the designer assumes a value for one of the resistors.

Copyright © 1998–2013, Texas Instruments Incorporated

The simplest approach is to assume a value for R3. Best results will typically be obtained using values between about **20 kΩ and 100 kΩ** (this keeps the current drain low, but also generates realistic values for the other resistors).

There is no limit on the **minimum value** of R3, but current should be minimized as it generates power that drains the source and does not power the load.

SUMMARY: TO SOLVE FOR R1, R2 AND R3:

1. Assume a value for either R1 or R3.
2. Solve for the other variable using the equation for R1 or R3.
3. Take the values for R1 and R3 and plug them back into **either** equation for R2 and solve for this value.

DESIGN EXAMPLE #1:

A 5V regulated output is to be powered from a transformer secondary which is rectified and filtered. The voltage V_{IN} is measured at zero current and maximum current (600 mA) to determine the minimum allowable hysteresis.

V_{IN} is measured using an oscilloscope (both traces are shown on the same grid for clarity):

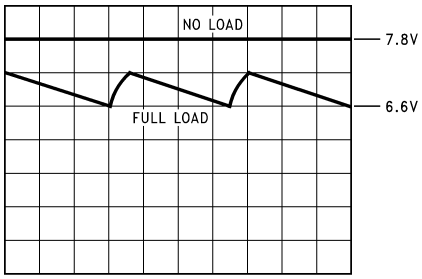


Figure 37. V_{IN} VOLTAGE WAVEFORMS

The full-load voltage waveform from a transformer-powered supply will have ripple voltage as shown. The correct point to measure is the **lowest** value of the waveform.

The 1.2V differential between no-load and full-load conditions means that **at least 1.2V** of hysteresis is required for proper snap-on/snap-off operation (for this example, **we will use 1.5V**).

As a starting point, we will assume:

V_{OFF} = 5.5V V_{ON} = V_{OFF} + HYST = 5.5 + 1.5 = 7V R3 = 49.9k

Solving for R1:

$$R1 = \frac{R3 \times (V_{OFF} + 3.07V_{ON} - 5)}{V_{ON} - V_{OFF}}$$

$$R1 = \frac{49.9k \times (5.5 + (3.07 \times 7) - 5)}{7 - 5.5}$$

$$\mathbf{R1 = 731k\ (standard\ size\ 732k)} \tag{8}$$

Solving for R2:

$$R2 = \frac{(R1 \times R3) \times V_{ON} - 1.23)}{1.23 \times (R1 + R3)}$$

$$R2 = \frac{(732k \times 49.9k) \times (7 - 1.23)}{1.23 \times (732k + 49.9k}$$

$$\mathbf{R2 = 219k\ (standard\ size\ 221k)} \tag{9}$$

Copyright © 1998–2013, Texas Instruments Incorporated

DESIGN EXAMPLE #2:

A 5V regulated output is to be powered from a battery made up of six NiCad cells. The cell data is:

cell voltage (full charged): 1.4V

cell voltage (90% discharged): 1.0V

The internal impedance of a typical battery is low enough that source loading during regulator turn-on is not usually a problem.

In a battery-powered application, the turn-off voltage V_{OFF} should be selected so that the regulator is shut down when the batteries are about 90% discharged (over discharge can damage rechargeable batteries).

In this case, the battery voltage will be **6.0V** at the 90% discharge point (since there are six cells at 1.0V each). That means for this application, V_{OFF} will be set to 6.0V.

Selecting the optimum voltage for V_{ON} requires understanding battery behavior. If a Ni-Cad battery is nearly discharged (cell voltage 1.0V) **and the load is removed**, the cell voltage will drift back up. The voltage where the regulator turns on must be set high enough to keep the regulator from re-starting during this time, or an on-off pulsing mode can occur.

If the regulator restarts when the discharged cell voltage drifts up, the load on the battery will cause the cell voltage to fall below the turn-off level, which causes the regulator to shut down. The cell voltage will again float up and the on-off cycling will continue.

For NiCad batteries, a good cell voltage to use to calculate V_{ON} is about 1.2V per cell. In this application, this will yield a value for V_{ON} of 7.2V.

We can now find R1, R2 and R3 assuming:

V_{OFF} = 6.0V V_{ON} = 7.2V R3 = 49.9k

Solving for R1:

$$R1 = \frac{R3 \times (V_{OFF} + 3.07V_{ON} - 5)}{V_{ON} - V_{OFF}}$$

$$R1 = \frac{49.9k \times (6 + (3.07 \times 7.2) - 5)}{7.2 - 6}$$

$$\mathbf{R1 = 961k\ (standard\ size\ 953k)} \tag{10}$$

Solving for R2:

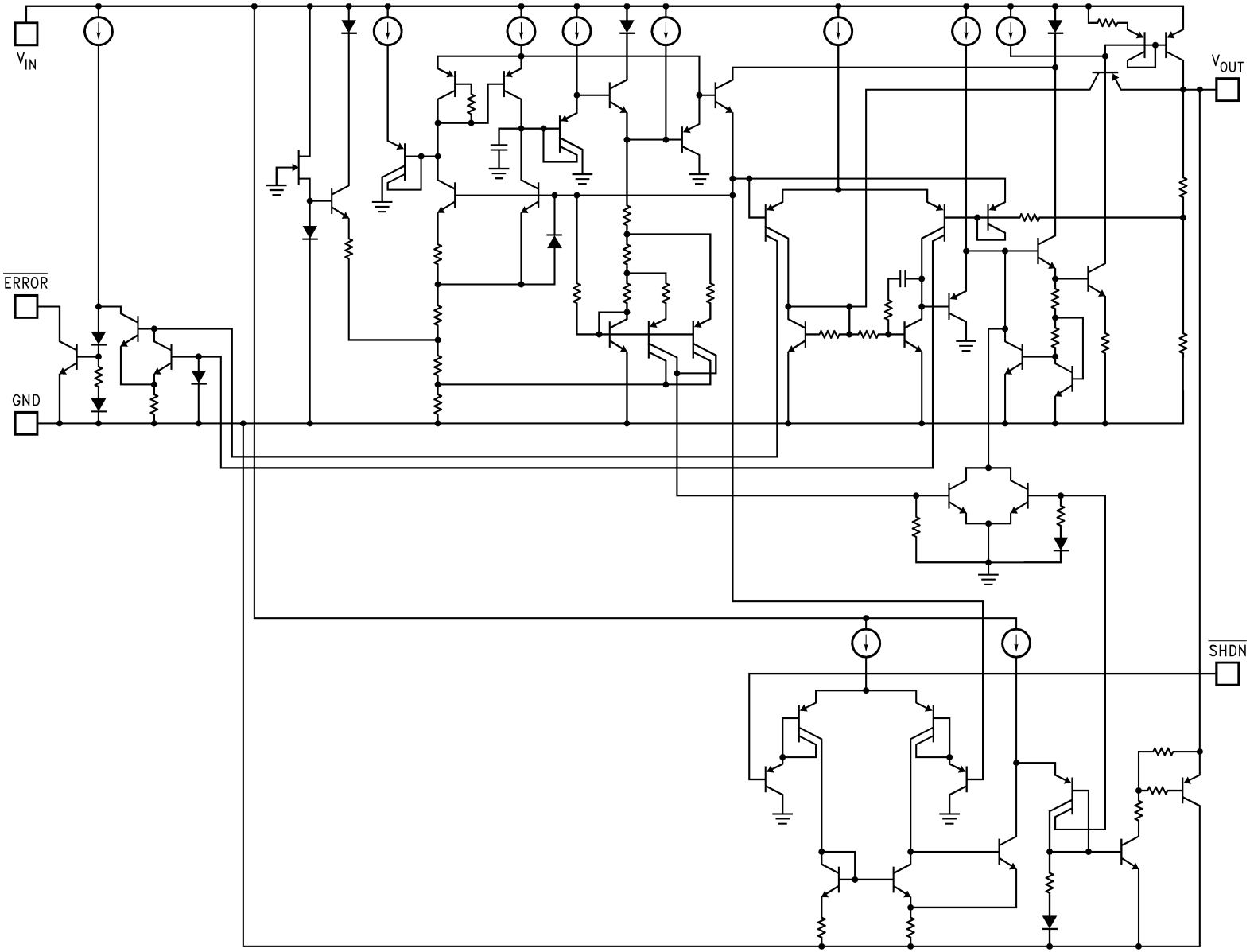
$$R2 = \frac{(R1 \times R3) \times (V_{ON} - 1.23)}{1.23 \times (R1 + R3)}$$

$$R2 = \frac{(953k \times 49.9k) \times (7.2 - 1.23)}{1.23 \times (953k + 49.9k)}$$

$$\mathbf{R2 = 230k\ (standard\ size\ 232k)} \tag{11}$$

Copyright © 1998–2013, Texas Instruments Incorporated

Schematic Diagram



Copyright © 1998–2013, Texas Instruments Incorporated

REVISION HISTORY

Changes from Revision B (April 2013) to Revision C	Page
• Changed layout of National Data Sheet to TI format	16

Copyright © 1998–2013, Texas Instruments Incorporated

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LP2957AISX/NOPB	ACTIVE	DDPAK/ TO-263	KTT	5	500	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LP2957AIS	Samples
LP2957AIT	LIFEBUY	TO-220	NDH	5	45	TBD	Call TI	Call TI	-40 to 125	LP2957AIT	
LP2957AIT/NOPB	ACTIVE	TO-220	NDH	5	45	Green (RoHS & no Sb/Br)	CU SN	Level-1-NA-UNLIM	-40 to 125	LP2957AIT	Samples
LP2957IS/NOPB	LIFEBUY	DDPAK/ TO-263	KTT	5	45	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LP2957IS	
LP2957ISX/NOPB	ACTIVE	DDPAK/ TO-263	KTT	5	500	Pb-Free (RoHS Exempt)	CU SN	Level-3-245C-168 HR	-40 to 125	LP2957IS	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

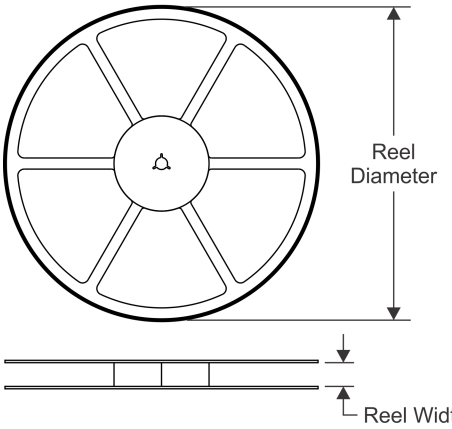
(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

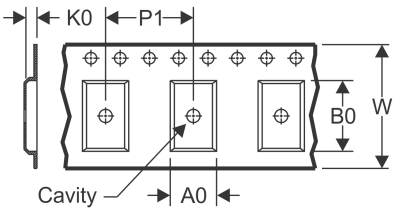
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TAPE AND REEL INFORMATION

REEL DIMENSIONS

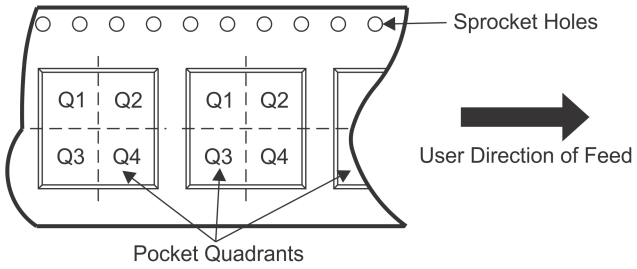


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

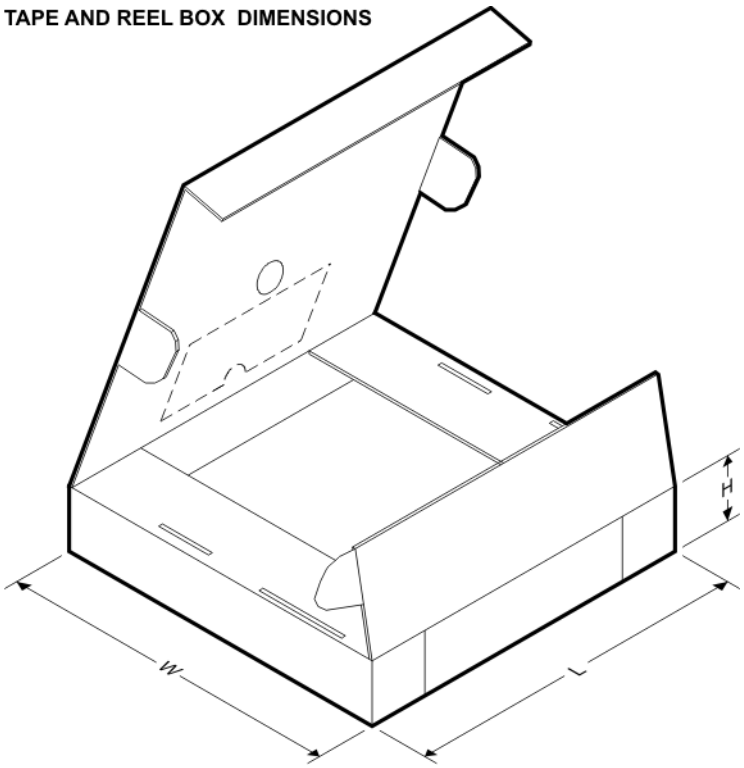
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LP2957AISX/NOPB	DDPAK/ TO-263	KTT	5	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2
LP2957ISX/NOPB	DDPAK/ TO-263	KTT	5	500	330.0	24.4	10.75	14.85	5.0	16.0	24.0	Q2

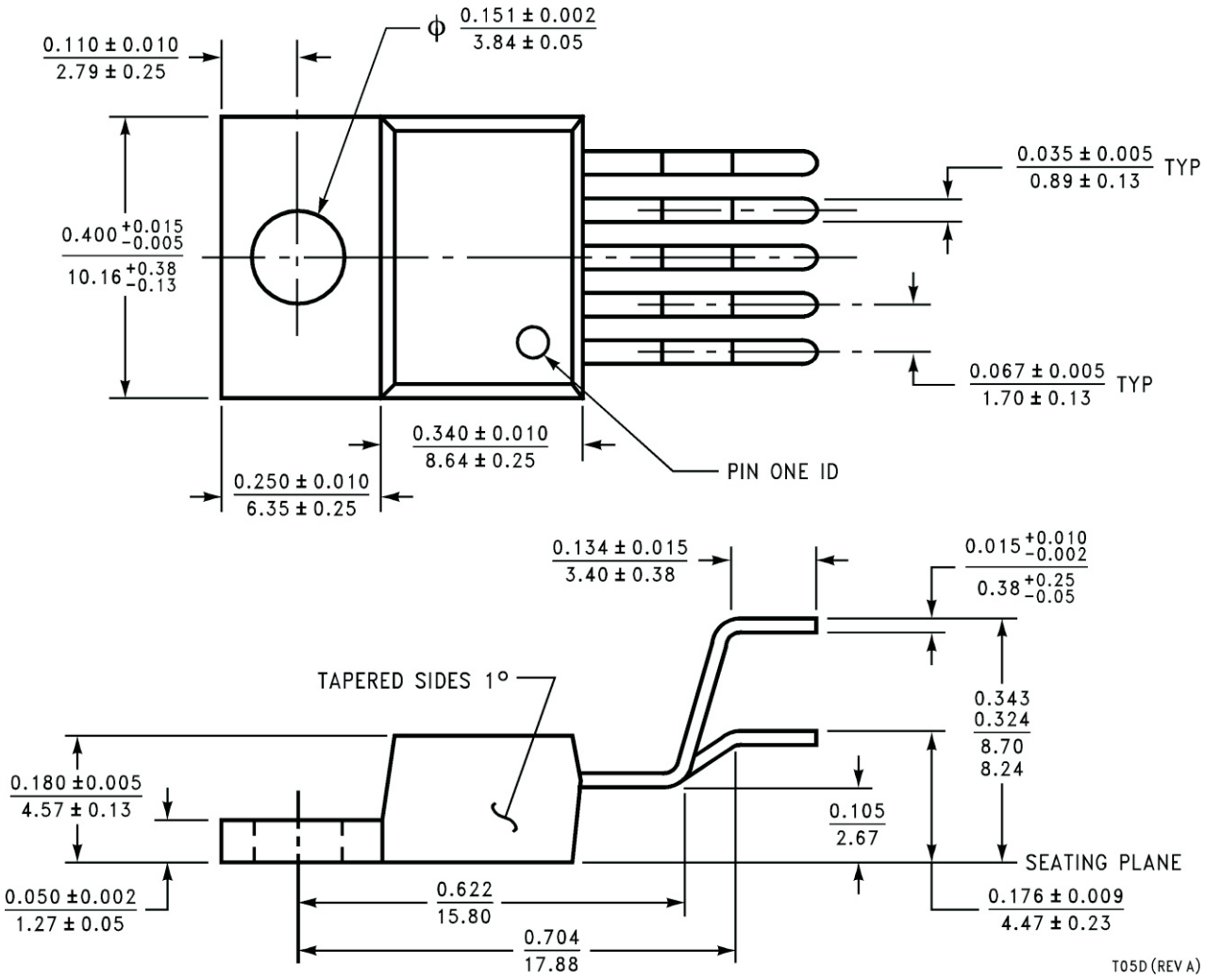
TAPE AND REEL BOX DIMENSIONS



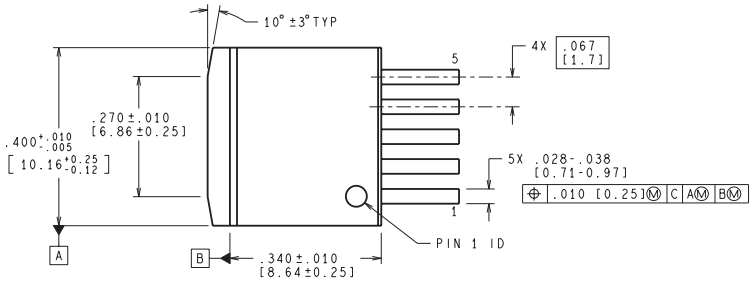
*All dimensions are nominal

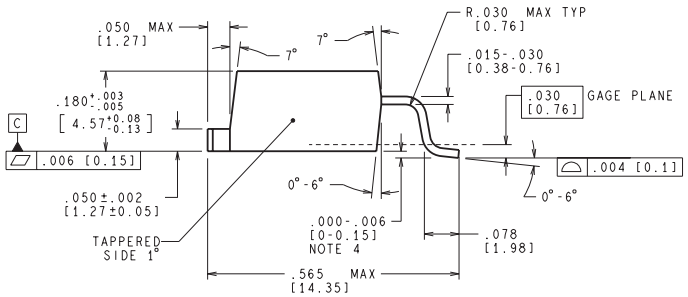
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LP2957AISX/NOPB	DDPAK/TO-263	KTT	5	500	367.0	367.0	45.0
LP2957ISX/NOPB	DDPAK/TO-263	KTT	5	500	367.0	367.0	45.0

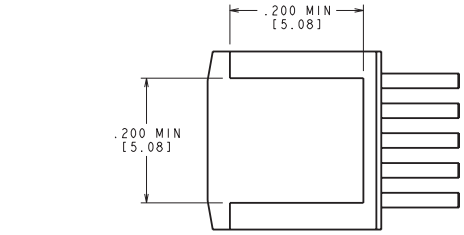
NDH0005D


0.110 ± 0.010
2.79 ± 0.25
ϕ 0.151 ± 0.002
3.84 ± 0.05
0.035 ± 0.005
0.89 ± 0.13
TYP
0.400 +0.015 −0.005
10.16 +0.38 −0.13
0.067 ± 0.005
1.70 ± 0.13
TYP
0.340 ± 0.010
8.64 ± 0.25
PIN ONE ID
0.250 ± 0.010
6.35 ± 0.25
0.134 ± 0.015
3.40 ± 0.38
0.015 +0.010 −0.002
0.38 +0.25 −0.05
TAPERED SIDES 1°
0.343
0.324
8.70
8.24
0.180 ±0.005
4.57 ± 0.13
0.105
2.67
SEATING PLANE
0.050 ±0.002
1.27 ± 0.05
0.622
15.80
0.176 ± 0.009
4.47 ± 0.23
0.704
17.88
T05D (REV A)

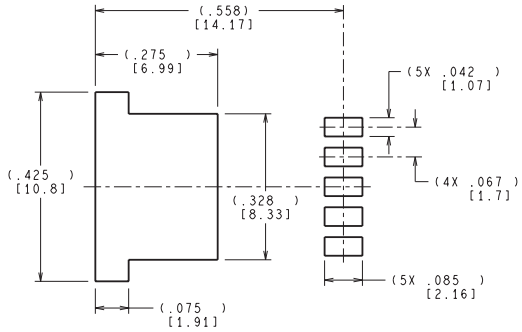
KTT0005B







BOTTOM SIDE OF PACKAGE



LAND PATTERN RECOMMENDATION

CONTROLLING DIMENSION IS INCH
VALUES IN [ ] ARE MILLIMETERS
DIMENSIONS IN ( ) FOR REFERENCE ONLY

TS5B (Rev D)

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as “components”) are sold subject to TI’s terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI’s terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers’ products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers’ products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI’s goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or “enhanced plastic” are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have ***not*** been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products		**Applications**	
Audio	www.ti.com/audio	Automotive and Transportation	www.ti.com/automotive
Amplifiers	amplifier.ti.com	Communications and Telecom	www.ti.com/communications
Data Converters	dataconverter.ti.com	Computers and Peripherals	www.ti.com/computers
DLP® Products	www.dlp.com	Consumer Electronics	www.ti.com/consumer-apps
DSP	dsp.ti.com	Energy and Lighting	www.ti.com/energy
Clocks and Timers	www.ti.com/clocks	Industrial	www.ti.com/industrial
Interface	interface.ti.com	Medical	www.ti.com/medical
Logic	logic.ti.com	Security	www.ti.com/security
Power Mgmt	power.ti.com	Space, Avionics and Defense	www.ti.com/space-avionics-defense
Microcontrollers	microcontroller.ti.com	Video and Imaging	www.ti.com/video
RFID	www.ti-rfid.com		
OMAP Applications Processors	www.ti.com/omap	**TI E2E Community**	e2e.ti.com
Wireless Connectivity	www.ti.com/wirelessconnectivity		

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2015, Texas Instruments Incorporated